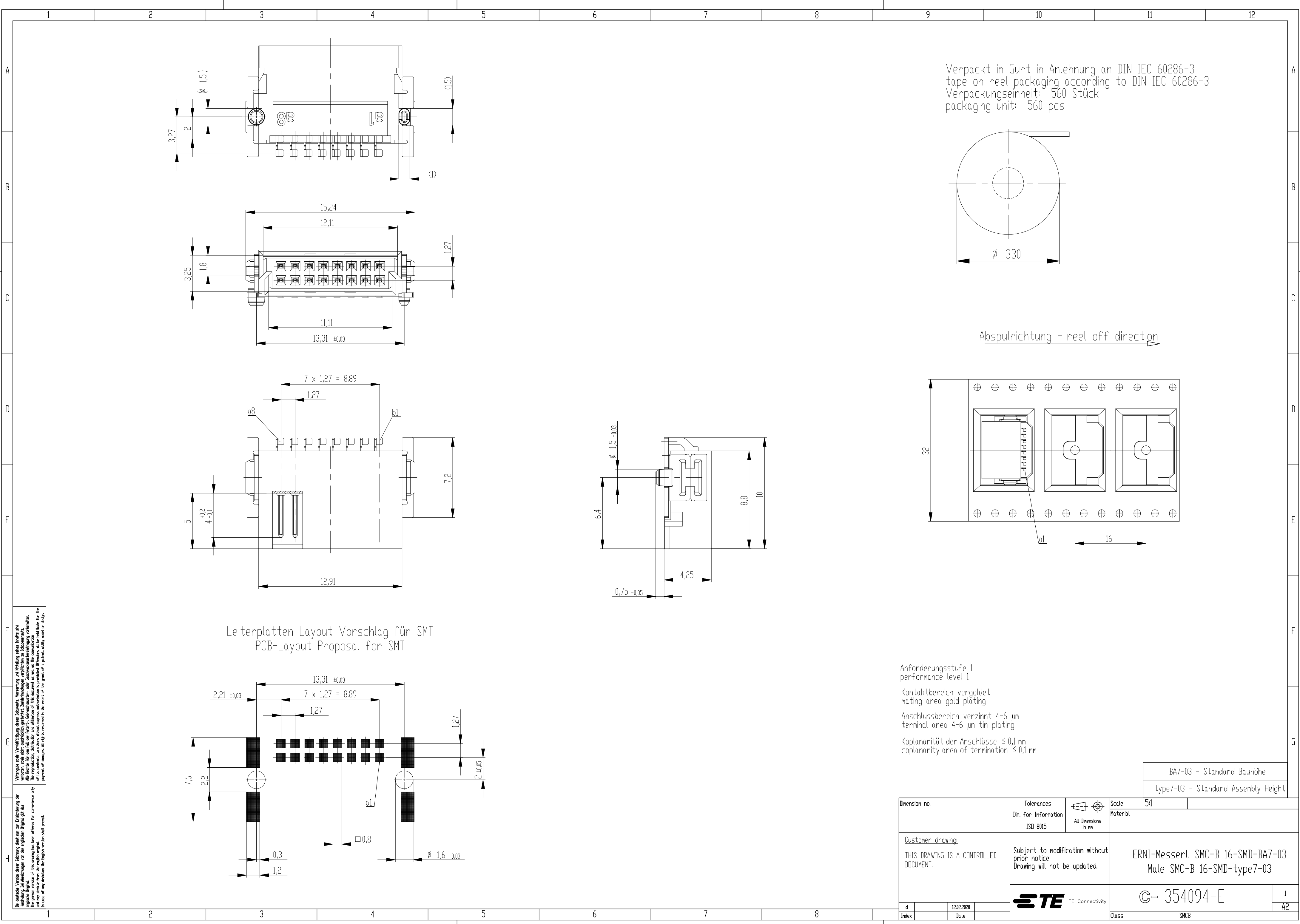


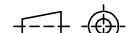


Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
tape on reel packaging according to DIN IEC 60286-3
Verpackungseinheit: 560 Stück
packaging unit: 560 pcs

Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT

Anforderungsstufe 1
performance level 1
Kontaktbereich verguldet
mating area gold plating
Anschlussbereich verzinkt 4-6 µm
terminal area 4-6 µm tin plating
Koplanarität der Anschlüsse ≤ 0,1 mm
coplanarity area of termination ≤ 0,1 mm

BA7-03 - Standard Bauhöhe
type7-03 - Standard Assembly Height

Dimension no.			Tolerances Dim. for Information ISO 8015		 All Dimensions in mm		Scale 5:1								
<u>Customer drawing:</u> THIS DRAWING IS A CONTROLLED DOCUMENT.			Subject to modification without prior notice. Drawing will not be updated.			ERNI-Messersl. SMC-B 16-SMD-BA7-03 Male SMC-B 16-SMD-type7-03									
			d				12.02.2020				 TE Connectivity		©= 354094-E		
Index				Date				Class					SMCB		A2

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